

# LNPTM KONDUIT™ COMPOUND 8TF36E

## DESCRIPTION

LNP KONDUIT 8TF36E compound is based on Liquid Crystal Polymer (LCP) resin containing 15% glass fibers and proprietary thermal filler. Added features of this grade include: Thermally Conductive, Electrically Insulative, High flow, Low Moisture Absorption, Low CTE values and suitable for light colors.

GENERAL INFORMATION	
Features	High Flow, Low Moisture Absorption, High temperature resistance, Thermally conductive/Electrically insulative, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Liquid Crystal Polymer (LCP)
Processing Techniques	Injection Molding

  

INDUSTRY	SUB INDUSTRY
Electrical and Electronics	Electronic Components
Industrial	Material Handling

## TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
<b>MECHANICAL <sup>(1)</sup></b>			
Tensile Stress, brk, Type I, 5 mm/min	125	MPa	ASTM D638
Tensile Strain, brk, Type I, 5 mm/min	2.3	%	ASTM D638
Tensile Modulus, 5 mm/min	13000	MPa	ASTM D638
Flexural Strength, 1.3 mm/min, 50 mm span	165	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	12000	MPa	ASTM D790
Tensile Stress, break, 5 mm/min	127	MPa	ISO 527
Tensile Strain, break, 5 mm/min	2.2	%	ISO 527
Tensile Modulus, 1 mm/min	13030	MPa	ISO 527
Flexural Strength, 2 mm/min	170	MPa	ISO 178
Flexural Modulus, 2 mm/min	13160	MPa	ISO 178
<b>IMPACT <sup>(1)</sup></b>			
Izod Impact, notched, 23°C	70	J/m	ASTM D256
Izod Impact, notched, -30°C	68	J/m	ASTM D256
Izod Impact, unnotched, 23°C	400	J/m	ASTM D4812
Izod Impact, unnotched, -30°C	350	J/m	ASTM D4812
Izod Impact, notched 80*10*3 +23°C	7.6	kJ/m <sup>2</sup>	ISO 180/1A
Izod Impact, notched 80*10*3 -30°C	7.1	kJ/m <sup>2</sup>	ISO 180/1A
Izod Impact, unnotched 80*10*3 +23°C	21.4	kJ/m <sup>2</sup>	ISO 180/1U
Izod Impact, unnotched 80*10*3 -30°C	17.4	kJ/m <sup>2</sup>	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	7.7	kJ/m <sup>2</sup>	ISO 180/1A
Izod Impact, notched 80*10*4 -30°C	8.3	kJ/m <sup>2</sup>	ISO 180/1A
Izod Impact, unnotched 80*10*4 +23°C	21.7	kJ/m <sup>2</sup>	ISO 180/1U
Izod Impact, unnotched 80*10*4 -30°C	18.3	kJ/m <sup>2</sup>	ISO 180/1U

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Charpy 23°C, V-notch Edgew 80*10*3 sp=62mm	8.2	kJ/m <sup>2</sup>	ISO 179/1eA
Charpy -30°C, V-notch Edgew 80*10*3 sp=62mm	8.1	kJ/m <sup>2</sup>	ISO 179/1eA
Charpy 23°C, Unnotch Edgew 80*10*3 sp=62mm	20.9	kJ/m <sup>2</sup>	ISO 179/1eU
Charpy -30°C, Unnotch Edgew 80*10*3 sp=62mm	17.6	kJ/m <sup>2</sup>	ISO 179/1eU
Charpy 23°C, V-notch Edgew 80*10*4 sp=62mm	8.4	kJ/m <sup>2</sup>	ISO 179/1eA
Charpy -30°C, V-notch Edgew 80*10*4 sp=62mm	9.1	kJ/m <sup>2</sup>	ISO 179/1eA
Charpy 23°C, Unnotch Edgew 80*10*4 sp=62mm	21.8	kJ/m <sup>2</sup>	ISO 179/1eU
Charpy -30°C, Unnotch Edgew 80*10*4 sp=62mm	18	kJ/m <sup>2</sup>	ISO 179/1eU
Instrumented Dart Impact Total Energy, 23°C	6.6	J	ASTM D3763
Instrumented Dart Impact Energy @ peak, 23°C	3.4	J	ASTM D3763
<b>THERMAL <sup>(1)</sup></b>			
HDT, 0.45 MPa, 3.2 mm, unannealed	280	°C	ASTM D648
HDT, 1.82 MPa, 3.2mm, unannealed	265	°C	ASTM D648
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	>280	°C	ISO 75/Bf
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	261	°C	ISO 75/Af
CTE, 23°C to 150°C, flow	1.0E-05	1/°C	ASTM E831
CTE, 23°C to 150°C, xflow	5.5E-05	1/°C	ASTM E831
CTE, 23°C to 150°C, flow	1.1E-05	1/°C	ISO 11359-2
CTE, 23°C to 150°C, xflow	6.5E-05	1/°C	ISO 11359-2
Vicat Softening Temp, Rate B/50	204	°C	ISO 306
Vicat Softening Temp, Rate B/120	207	°C	ISO 306
Thermal Conductivity in-plane, 25*0.4mm disc	4.5	W/m-K	ASTM E1461-07
Thermal Conductivity through-plane, 10*10*3mm sample	1	W/m-K	ASTM E1461-07
<b>PHYSICAL <sup>(1)</sup></b>			
Specific Gravity	1.72	-	ASTM D792
Water Absorption, (23°C/24hrs)	0.02	%	ISO 62-1
<b>Melt Flow Rate</b>			
345°C/2.16 kgf	150	g/10 min	ASTM D1238
Mold Shrinkage, flow <sup>(2)</sup>	0.1	%	SABIC method
Mold Shrinkage, xflow <sup>(2)</sup>	0.2	%	SABIC method
<b>ELECTRICAL <sup>(1)</sup></b>			
Surface Resistivity	1.E+16	Ω	ASTM D257
Volume Resistivity	1.E+16	Ω.cm	ASTM D257
Dielectric Constant, 1.1 GHz	4.06	-	SABIC method
Dissipation Factor, 1.1 GHz	0.00307	-	SABIC method
Dielectric Constant, 1.9 GHz	4.12	-	SABIC method
Dissipation Factor, 1.9 GHz	0.00289	-	SABIC method
Dielectric Constant, 5 GHz	4.07	-	SABIC method
Dissipation Factor, 5 GHz	0.00263	-	SABIC method
Dielectric Constant, 10 GHz	4.08	-	SABIC method
Dissipation Factor, 10 GHz	0.00285	-	SABIC method
<b>INJECTION MOLDING <sup>(3)</sup></b>			
Drying Temperature	140 – 150	°C	
Drying Time	4 – 6	Hrs	
Melt Temperature	335 – 345	°C	

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Nozzle Temperature	335 – 345	°C	
Front - Zone 3 Temperature	335 – 345	°C	
Middle - Zone 2 Temperature	335 – 340	°C	
Rear - Zone 1 Temperature	280 – 300	°C	
Mold Temperature	100 – 120	°C	
Back Pressure	0.1 – 0.4	MPa	
Screw Speed	80 – 100	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

## ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

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